

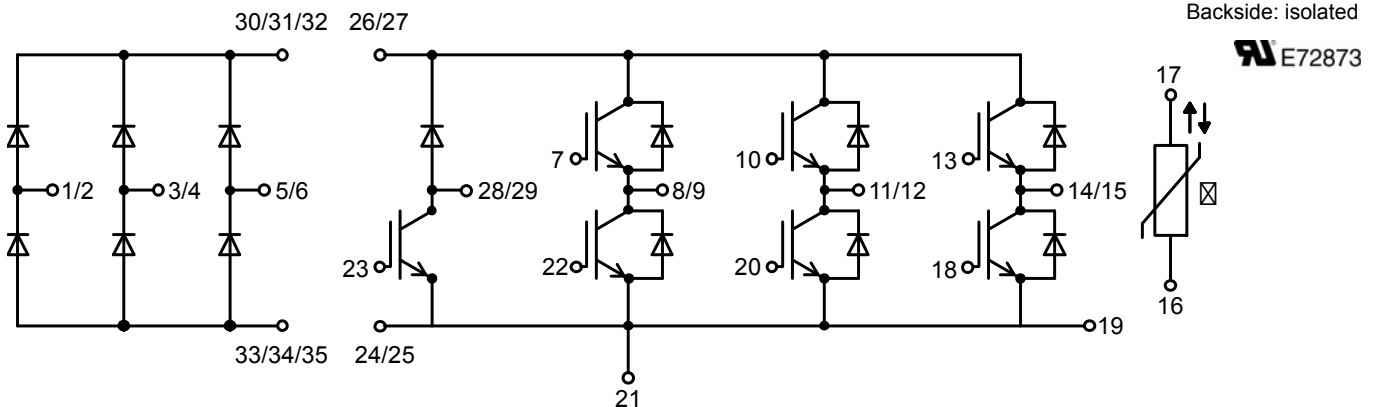
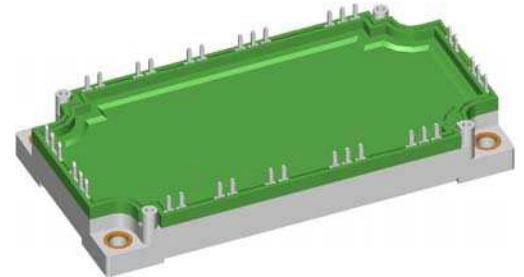
# XPT IGBT Module

| 3~<br>Rectifier            | Brake<br>Chopper              | 3~<br>Inverter                |
|----------------------------|-------------------------------|-------------------------------|
| $V_{RRM} = 1600 \text{ V}$ | $V_{CES} = 1200 \text{ V}$    | $V_{CES} = 1200 \text{ V}$    |
| $I_{DAV} = 290 \text{ A}$  | $I_{C25} = 90 \text{ A}$      | $I_{C25} = 120 \text{ A}$     |
| $I_{FSM} = 1200 \text{ A}$ | $V_{CE(sat)} = 1.8 \text{ V}$ | $V_{CE(sat)} = 1.8 \text{ V}$ |

6-Pack + 3~ Rectifier Bridge & Brake Unit + NTC

Part number

**MIXA81WB1200TEH**



## Features / Advantages:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10  $\mu\text{sec}$ .
  - very low gate charge
  - low EMI
  - square RBSOA @ 3x Ic
- Thin wafer technology combined with the XPT design results in a competitive low  $V_{CE(sat)}$
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

## Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

## Package: E3-Pack

- Isolation Voltage: 3600V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: Copper internally DCB isolated
- Advanced power cycling

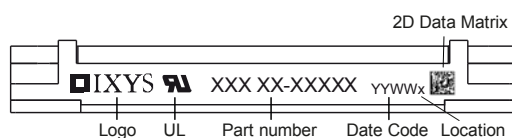
| Rectifier  |                                              |                                         |                                | Ratings                        |      |      |                   |
|------------|----------------------------------------------|-----------------------------------------|--------------------------------|--------------------------------|------|------|-------------------|
| Symbol     | Definition                                   | Conditions                              |                                | min.                           | typ. | max. | Unit              |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^{\circ}\text{C}$           |                                |                                |      | 1700 | V                 |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     | $T_{VJ} = 25^{\circ}\text{C}$           |                                |                                |      | 1600 | V                 |
| $I_R$      | reverse current, drain current               | $V_R = 1600\text{ V}$                   | $T_{VJ} = 25^{\circ}\text{C}$  |                                |      | 100  | $\mu\text{A}$     |
|            |                                              | $V_R = 1600\text{ V}$                   | $T_{VJ} = 125^{\circ}\text{C}$ |                                |      | 0.5  | mA                |
| $V_F$      | forward voltage drop                         | $I_F = 120\text{ A}$                    | $T_{VJ} = 25^{\circ}\text{C}$  |                                |      | 1.23 | V                 |
|            |                                              | $I_F = 240\text{ A}$                    |                                |                                |      |      | V                 |
|            |                                              | $I_F = 120\text{ A}$                    | $T_{VJ} = 125^{\circ}\text{C}$ |                                |      | 1.19 | V                 |
|            |                                              | $I_F = 240\text{ A}$                    |                                |                                |      |      | V                 |
| $I_{DAV}$  | bridge output current                        | $T_C = 80^{\circ}\text{C}$              | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 290  | A                 |
|            |                                              | rectangular $d = \frac{1}{3}$           |                                |                                |      |      |                   |
| $V_{F0}$   | threshold voltage                            | } for power loss calculation only       |                                | $T_{VJ} = 150^{\circ}\text{C}$ |      | 0.85 | V                 |
| $r_F$      | slope resistance                             |                                         |                                |                                |      | 2.7  | m $\Omega$        |
| $R_{thJC}$ | thermal resistance junction to case          |                                         |                                |                                |      | 0.45 | K/W               |
| $R_{thCH}$ | thermal resistance case to heatsink          |                                         |                                |                                | 0.10 |      | K/W               |
| $P_{tot}$  | total power dissipation                      | $T_C = 25^{\circ}\text{C}$              |                                |                                |      | 280  | W                 |
| $I_{FSM}$  | max. forward surge current                   | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 45^{\circ}\text{C}$  |                                |      | 1.20 | kA                |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 1.30 | kA                |
|            |                                              | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 1.02 | kA                |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 1.10 | kA                |
| $I^2t$     | value for fusing                             | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 45^{\circ}\text{C}$  |                                |      | 7.20 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 6.98 | kA <sup>2</sup> s |
|            |                                              | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 5.20 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 5.04 | kA <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 600\text{ V}$ $f = 1\text{ MHz}$ | $T_{VJ} = 25^{\circ}\text{C}$  |                                | 26   |      | pF                |

| Brake IGBT    |                                       |                                                                                                              |                                | Ratings |      |          |               |
|---------------|---------------------------------------|--------------------------------------------------------------------------------------------------------------|--------------------------------|---------|------|----------|---------------|
| Symbol        | Definition                            | Conditions                                                                                                   |                                | min.    | typ. | max.     | Unit          |
| $V_{CES}$     | collector emitter voltage             | $T_{VJ} = 25^{\circ}\text{C}$                                                                                |                                |         |      | 1200     | V             |
| $V_{GES}$     | max. DC gate voltage                  |                                                                                                              |                                |         |      | $\pm 20$ | V             |
| $V_{GEM}$     | max. transient collector gate voltage |                                                                                                              |                                |         |      | $\pm 30$ | V             |
| $I_{C25}$     | collector current                     | $T_C = 25^{\circ}\text{C}$                                                                                   |                                |         |      | 90       | A             |
| $I_{C80}$     |                                       | $T_C = 80^{\circ}\text{C}$                                                                                   |                                |         |      | 60       | A             |
| $P_{tot}$     | total power dissipation               | $T_C = 25^{\circ}\text{C}$                                                                                   |                                |         |      | 290      | W             |
| $V_{CE(sat)}$ | collector emitter saturation voltage  | $I_C = 55\text{ A}; V_{GE} = 15\text{ V}$                                                                    | $T_{VJ} = 25^{\circ}\text{C}$  |         | 1.8  | 2.1      | V             |
|               |                                       |                                                                                                              | $T_{VJ} = 125^{\circ}\text{C}$ |         | 2.1  |          | V             |
| $V_{GE(th)}$  | gate emitter threshold voltage        | $I_C = 2\text{ mA}; V_{GE} = V_{CE}$                                                                         | $T_{VJ} = 25^{\circ}\text{C}$  | 5.4     | 5.9  | 6.5      | V             |
| $I_{CES}$     | collector emitter leakage current     | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$                                                                      | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.1      | mA            |
|               |                                       |                                                                                                              | $T_{VJ} = 125^{\circ}\text{C}$ |         | 0.1  |          | mA            |
| $I_{GES}$     | gate emitter leakage current          | $V_{GE} = \pm 20\text{ V}$                                                                                   |                                |         |      | 500      | nA            |
| $Q_{G(on)}$   | total gate charge                     | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 55\text{ A}$                                             |                                |         | 165  |          | nC            |
| $t_{d(on)}$   | turn-on delay time                    | inductive load<br>$V_{CE} = 600\text{ V}; I_C = 55\text{ A}$<br>$V_{GE} = \pm 15\text{ V}; R_G = 15\ \Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ |         | 70   |          | ns            |
| $t_r$         | current rise time                     |                                                                                                              |                                |         | 40   |          | ns            |
| $t_{d(off)}$  | turn-off delay time                   |                                                                                                              |                                |         | 250  |          | ns            |
| $t_f$         | current fall time                     |                                                                                                              |                                |         | 100  |          | ns            |
| $E_{on}$      | turn-on energy per pulse              |                                                                                                              |                                |         | 4.5  |          | mJ            |
| $E_{off}$     | turn-off energy per pulse             |                                                                                                              |                                |         | 5.5  |          | mJ            |
| RBSOA         | reverse bias safe operating area      | $V_{GE} = \pm 15\text{ V}; R_G = 15\ \Omega$                                                                 | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $I_{CM}$      |                                       | $V_{CEK} = 1200\text{ V}$                                                                                    |                                |         |      | 150      | A             |
| SCSOA         | short circuit safe operating area     |                                                                                                              |                                |         |      |          |               |
| $t_{SC}$      | short circuit duration                | $V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V}$                                                            | $T_{VJ} = 125^{\circ}\text{C}$ |         |      | 10       | $\mu\text{s}$ |
| $I_{SC}$      | short circuit current                 | $R_G = 15\ \Omega$ ; non-repetitive                                                                          |                                |         | 200  |          | A             |
| $R_{thJC}$    | thermal resistance junction to case   |                                                                                                              |                                |         |      | 0.43     | K/W           |
| $R_{thCH}$    | thermal resistance case to heatsink   |                                                                                                              |                                |         | 0.10 |          | K/W           |
| Brake Diode   |                                       |                                                                                                              |                                |         |      |          |               |
| $V_{RRM}$     | max. repetitive reverse voltage       |                                                                                                              | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 1200     | V             |
| $I_{F25}$     | forward current                       |                                                                                                              | $T_C = 25^{\circ}\text{C}$     |         |      | 44       | A             |
| $I_{F80}$     |                                       |                                                                                                              | $T_C = 80^{\circ}\text{C}$     |         |      | 29       | A             |
| $V_F$         | forward voltage                       | $I_F = 30\text{ A}$                                                                                          | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 2.20     | V             |
|               |                                       |                                                                                                              | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.90 |          | V             |
| $I_R$         | reverse current                       | $V_R = V_{RRM}$                                                                                              | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.1      | mA            |
|               |                                       |                                                                                                              | $T_{VJ} = 125^{\circ}\text{C}$ |         |      | 2        | mA            |
| $Q_{rr}$      | reverse recovery charge               | $V_R = 600\text{ V}$<br>$-di_F/dt = 600\text{ A}/\mu\text{s}$<br>$I_F = 30\text{ A}$                         | $T_{VJ} = 125^{\circ}\text{C}$ |         | 3.5  |          | $\mu\text{C}$ |
| $I_{RM}$      | max. reverse recovery current         |                                                                                                              |                                |         | 30   |          | A             |
| $t_{rr}$      | reverse recovery time                 |                                                                                                              |                                |         | 350  |          | ns            |
| $E_{rec}$     | reverse recovery energy               |                                                                                                              |                                |         | 0.9  |          | mJ            |
| $R_{thJC}$    | thermal resistance junction to case   |                                                                                                              |                                |         |      | 1.2      | K/W           |
| $R_{thCH}$    | thermal resistance case to heatsink   |                                                                                                              |                                |         | 0.10 |          | K/W           |

| Inverter IGBT         |                                        |                                                                                                                    |                                | Ratings |      |          |               |
|-----------------------|----------------------------------------|--------------------------------------------------------------------------------------------------------------------|--------------------------------|---------|------|----------|---------------|
| Symbol                | Definition                             | Conditions                                                                                                         |                                | min.    | typ. | max.     | Unit          |
| $V_{CES}$             | collector emitter voltage              | $T_{VJ} = 25^{\circ}\text{C}$                                                                                      |                                |         |      | 1200     | V             |
| $V_{GES}$             | max. DC gate voltage                   |                                                                                                                    |                                |         |      | $\pm 20$ | V             |
| $V_{GEM}$             | max. transient collector gate voltage  |                                                                                                                    |                                |         |      | $\pm 30$ | V             |
| $I_{C25}$             | collector current                      | $T_C = 25^{\circ}\text{C}$                                                                                         |                                |         |      | 120      | A             |
| $I_{C80}$             |                                        | $T_C = 80^{\circ}\text{C}$                                                                                         |                                |         |      | 84       | A             |
| $P_{tot}$             | total power dissipation                | $T_C = 25^{\circ}\text{C}$                                                                                         |                                |         |      | 390      | W             |
| $V_{CE(sat)}$         | collector emitter saturation voltage   | $I_C = 75\text{ A}; V_{GE} = 15\text{ V}$                                                                          | $T_{VJ} = 25^{\circ}\text{C}$  |         | 1.8  | 2.1      | V             |
|                       |                                        |                                                                                                                    | $T_{VJ} = 125^{\circ}\text{C}$ |         | 2.1  |          | V             |
| $V_{GE(th)}$          | gate emitter threshold voltage         | $I_C = 3\text{ mA}; V_{GE} = V_{CE}$                                                                               | $T_{VJ} = 25^{\circ}\text{C}$  | 5.4     | 5.9  | 6.5      | V             |
| $I_{CES}$             | collector emitter leakage current      | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$                                                                            | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.2      | mA            |
|                       |                                        |                                                                                                                    | $T_{VJ} = 125^{\circ}\text{C}$ |         | 0.6  |          | mA            |
| $I_{GES}$             | gate emitter leakage current           | $V_{GE} = \pm 20\text{ V}$                                                                                         |                                |         |      | 500      | nA            |
| $Q_{G(on)}$           | total gate charge                      | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 75\text{ A}$                                                   |                                |         | 230  |          | nC            |
| $t_{d(on)}$           | turn-on delay time                     | inductive load<br>$V_{CE} = 600\text{ V}; I_C = 75\text{ A}$<br>$V_{GE} = \pm 15\text{ V}; R_G = 10\text{ }\Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ |         | 70   |          | ns            |
| $t_r$                 | current rise time                      |                                                                                                                    |                                |         | 40   |          | ns            |
| $t_{d(off)}$          | turn-off delay time                    |                                                                                                                    |                                |         | 250  |          | ns            |
| $t_f$                 | current fall time                      |                                                                                                                    |                                |         | 100  |          | ns            |
| $E_{on}$              | turn-on energy per pulse               |                                                                                                                    |                                |         | 6.8  |          | mJ            |
| $E_{off}$             | turn-off energy per pulse              |                                                                                                                    |                                |         | 8.3  |          | mJ            |
| <b>RBSOA</b>          | reverse bias safe operating area       | $V_{GE} = \pm 15\text{ V}; R_G = 10\text{ }\Omega$                                                                 | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $I_{CM}$              |                                        | $V_{CEmax} = 1200\text{ V}$                                                                                        |                                |         |      | 225      | A             |
| <b>SCSOA</b>          | short circuit safe operating area      | $V_{CEmax} = 1200\text{ V}$                                                                                        | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $t_{SC}$              | short circuit duration                 | $V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V}$                                                                  |                                |         |      | 10       | $\mu\text{s}$ |
| $I_{SC}$              | short circuit current                  | $R_G = 10\text{ }\Omega$ ; non-repetitive                                                                          |                                |         | 300  |          | A             |
| $R_{thJC}$            | thermal resistance junction to case    |                                                                                                                    |                                |         |      | 0.32     | K/W           |
| $R_{thCH}$            | thermal resistance case to heatsink    |                                                                                                                    |                                |         | 0.10 |          | K/W           |
| <b>Inverter Diode</b> |                                        |                                                                                                                    |                                |         |      |          |               |
| $V_{RRM}$             | max. repetitive reverse voltage        |                                                                                                                    | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 1200     | V             |
| $I_{F25}$             | forward current                        |                                                                                                                    | $T_C = 25^{\circ}\text{C}$     |         |      | 135      | A             |
| $I_{F80}$             |                                        |                                                                                                                    | $T_C = 80^{\circ}\text{C}$     |         |      | 90       | A             |
| $V_F$                 | forward voltage                        | $I_F = 100\text{ A}$                                                                                               | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 2.20     | V             |
|                       |                                        |                                                                                                                    | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.90 |          | V             |
| $I_R$                 | reverse current                        | $V_R = V_{RRM}$                                                                                                    | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | *        | mA            |
|                       | * not applicable, see Ices value above |                                                                                                                    | $T_{VJ} = 125^{\circ}\text{C}$ |         | *    |          | mA            |
| $Q_{rr}$              | reverse recovery charge                | $V_R = 600\text{ V}$<br>$-di_F/dt = 1600\text{ A}/\mu\text{s}$<br>$I_F = 100\text{ A}; V_{GE} = 0\text{ V}$        | $T_{VJ} = 125^{\circ}\text{C}$ |         | 12.5 |          | $\mu\text{C}$ |
| $I_{RM}$              | max. reverse recovery current          |                                                                                                                    |                                |         | 100  |          | A             |
| $t_{rr}$              | reverse recovery time                  |                                                                                                                    |                                |         | 350  |          | ns            |
| $E_{rec}$             | reverse recovery energy                |                                                                                                                    |                                |         | 4    |          | mJ            |
| $R_{thJC}$            | thermal resistance junction to case    |                                                                                                                    |                                |         |      | 0.4      | K/W           |
| $R_{thCH}$            | thermal resistance case to heatsink    |                                                                                                                    |                                |         | 0.10 |          | K/W           |

tentative

| Package E3-Pack |                                                              |                                  | Ratings      |      |      |        |
|-----------------|--------------------------------------------------------------|----------------------------------|--------------|------|------|--------|
| Symbol          | Definition                                                   | Conditions                       | min.         | typ. | max. | Unit   |
| $I_{RMS}$       | RMS current                                                  | per terminal                     |              |      | 300  | A      |
| $T_{stg}$       | storage temperature                                          |                                  | -40          |      | 125  | °C     |
| $T_{VJ}$        | virtual junction temperature                                 |                                  | -40          |      | 150  | °C     |
| Weight          |                                                              |                                  |              | 270  |      | g      |
| $M_D$           | mounting torque                                              |                                  | 3            |      | 6    | Nm     |
| $V_{ISOL}$      | isolation voltage                                            | $t = 1$ second<br>$t = 1$ minute | 3600<br>3000 |      |      | V<br>V |
| $d_{Spp/App}$   | creepage distance on surface   striking distance through air | terminal to terminal             | 6.0          |      |      | mm     |
| $d_{Spb/Apb}$   |                                                              | terminal to backside             | 12.0         |      |      | mm     |
| $R_{pin-chip}$  | resistance pin to chip                                       |                                  |              | 5    |      | mΩ     |



### Part number

M = Module  
I = IGBT  
X = XPT IGBT  
A = Gen 1 / std  
81 = Current Rating [A]  
WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit  
1200 = Reverse Voltage [V]  
T = Thermistor \ Temperature sensor  
EH = E3-Pack

| Ordering | Part Number     | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | MIXA81WB1200TEH | MIXA81WB1200TEH    | Box           | 5        | 512760   |

### Temperature Sensor NTC

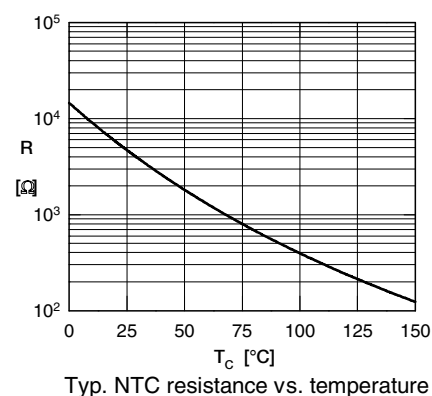
| Symbol      | Definition              | Conditions          | min. | typ. | max. | Unit |
|-------------|-------------------------|---------------------|------|------|------|------|
| $R_{25}$    | resistance              | $T_{VJ} = 25^\circ$ | 4.75 | 5    | 5.25 | kΩ   |
| $B_{25/50}$ | temperature coefficient |                     |      | 3375 |      | K    |

### Equivalent Circuits for Simulation

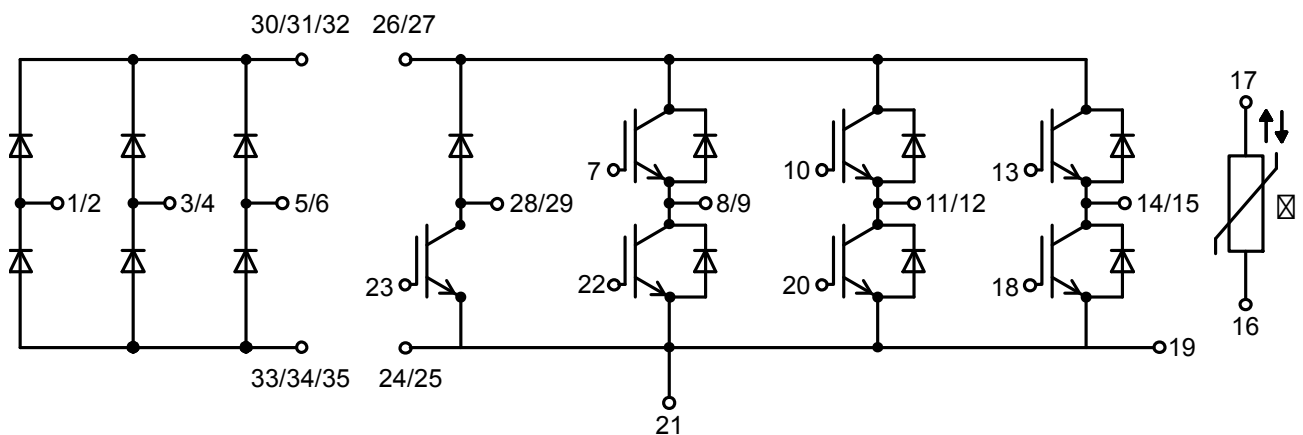
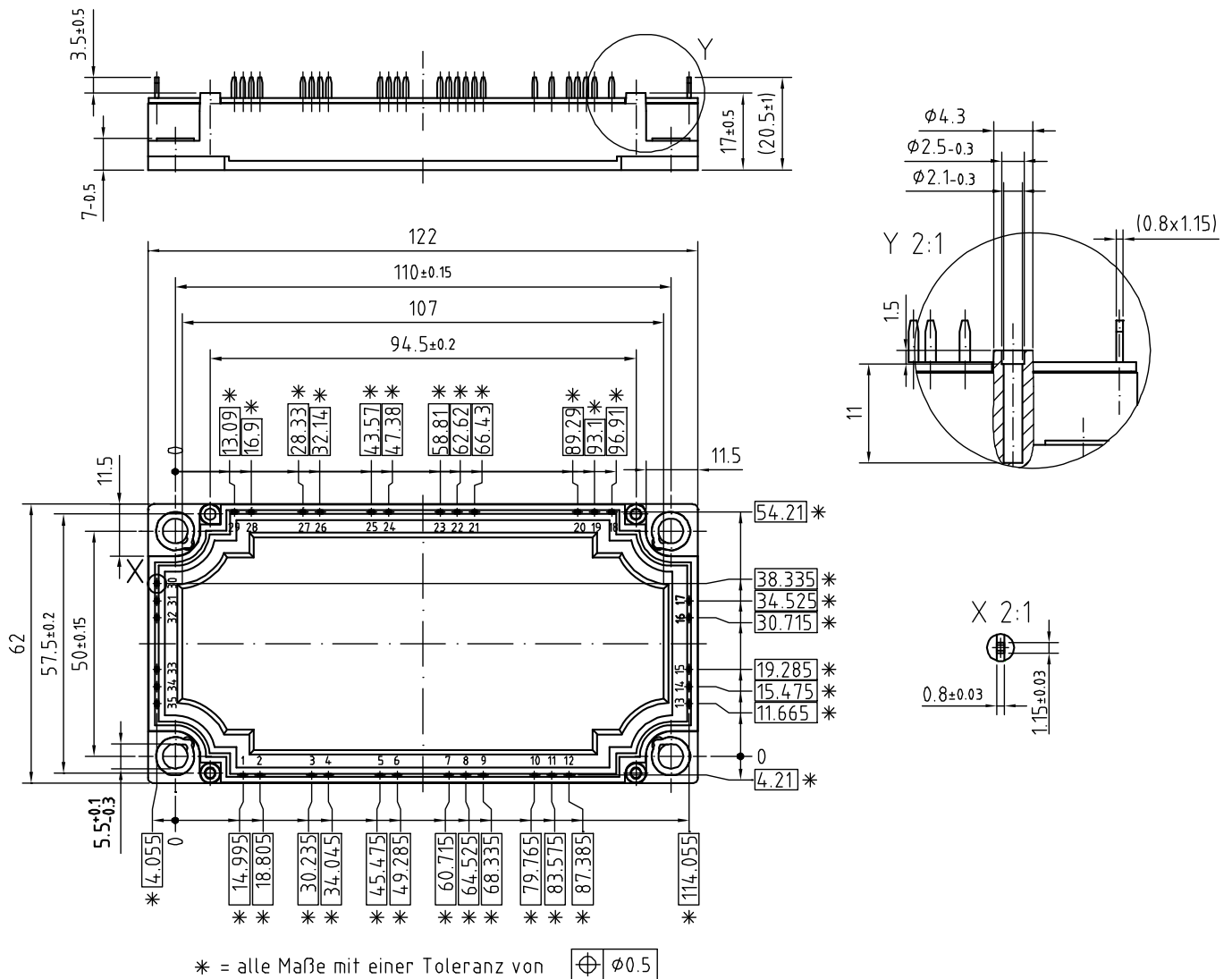
\* on die level

$T_{VJ} = 150^\circ\text{C}$

|       |                    | Rectifier | Brake IGBT | Brake Diode | Inverter IGBT | Inverter Diode |    |
|-------|--------------------|-----------|------------|-------------|---------------|----------------|----|
| $V_0$ | threshold voltage  | 0.85      | 1.1        | 1.2         | 1.1           | 1.35           | V  |
| $R_0$ | slope resistance * | 2.7       | 25         | 27          | 17.9          | 8.5            | mΩ |



## Outlines E3-Pack



## Rectifier

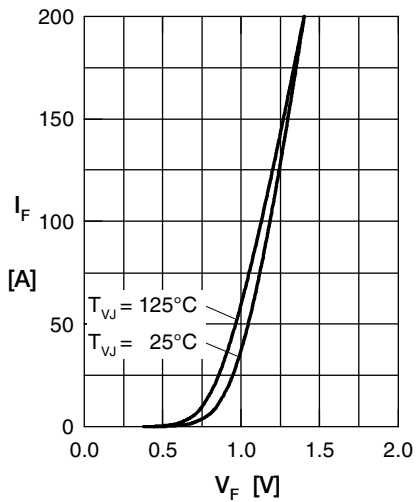


Fig. 1 Forward current versus voltage drop per diode

Fig. 2 Surge overload current

Fig. 3  $I^2t$  versus time per diode

Fig. 4 Power dissipation versus direct output current and ambient temperature, sine 180°

Fig. 5 Max. forward current versus case temperature

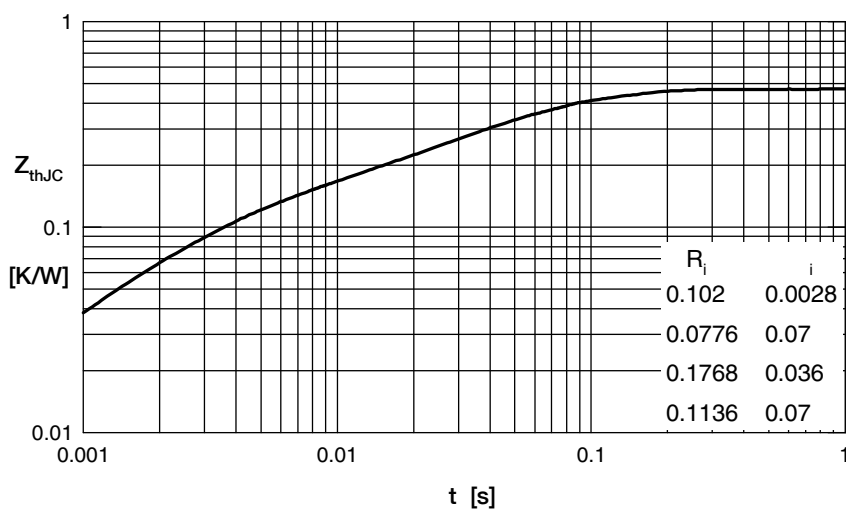


Fig. 6 Transient thermal impedance junction to case

## Brake IGBT

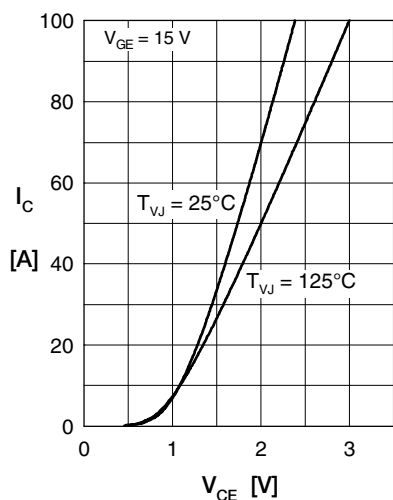


Fig. 1 Typ. output characteristics

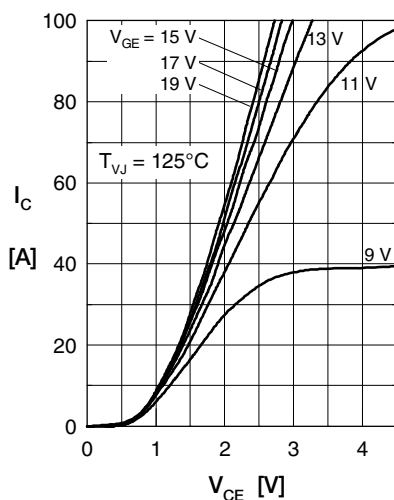


Fig. 2 Typ. output characteristics

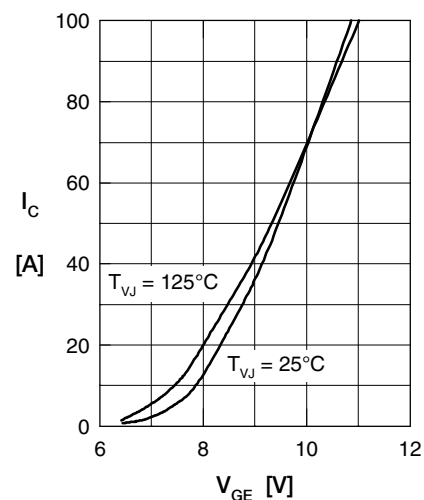


Fig. 3 Typ. tranfer characteristics

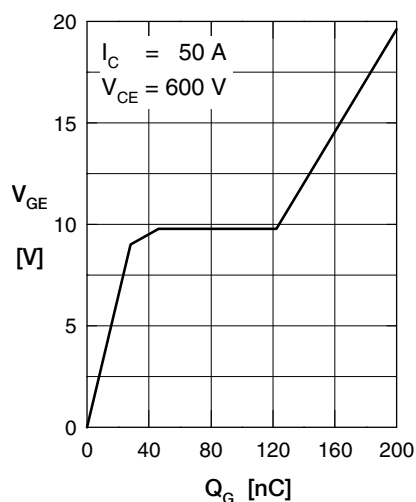


Fig. 4 Typ. turn-on gate charge

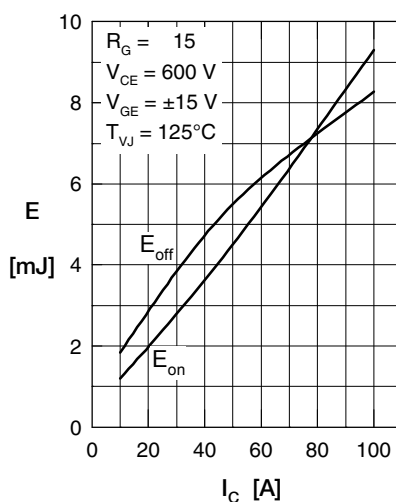
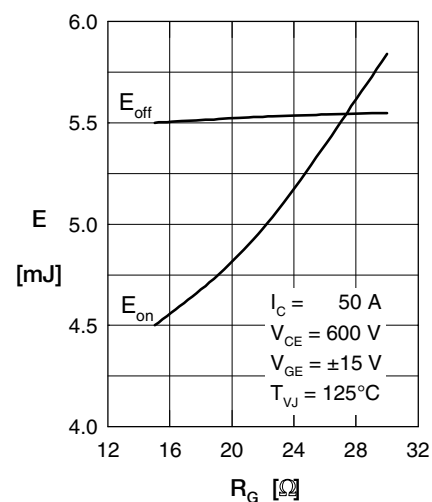
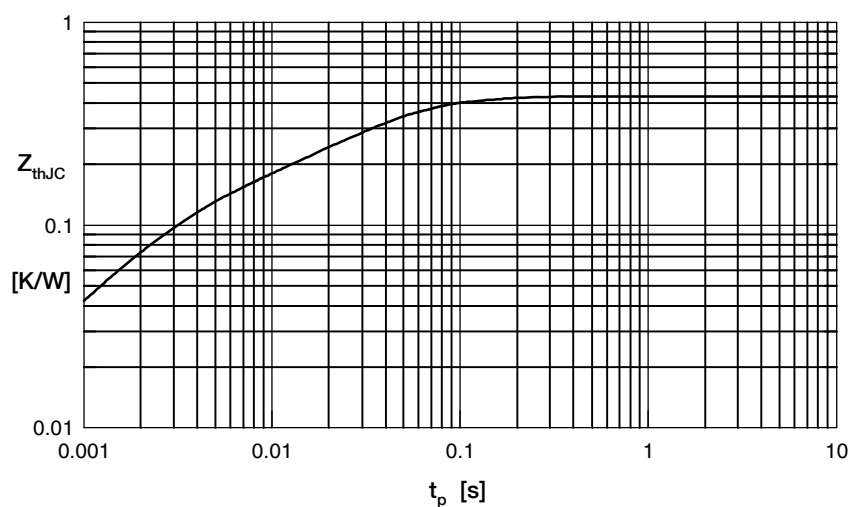

Fig. 5 Typ. switching energy  
versus collector current

Fig. 6 Typ. switching energy  
versus gate resistance


Fig. 7 Typ. transient thermal impedance



## Brake Diode

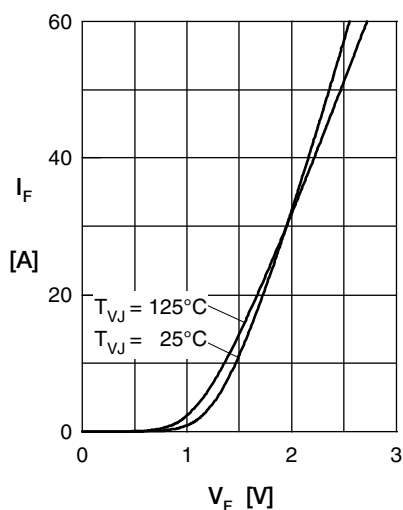


Fig. 1 Typ. Forward current  $I_F$  versus  $V_F$

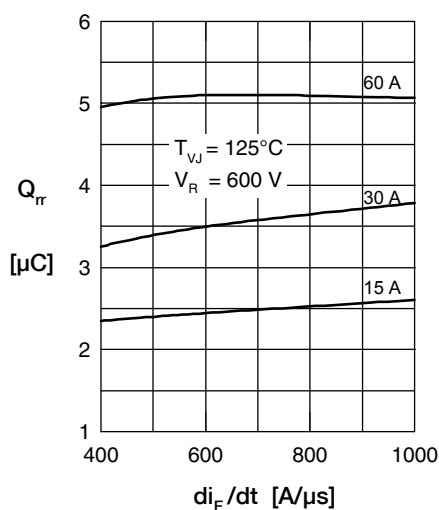


Fig. 2 Typ. reverse recov. charge  $Q_{rr}$  versus  $di_F/dt$

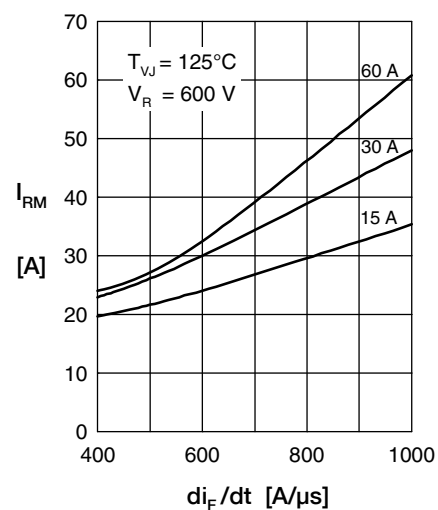


Fig. 3 Typ. peak reverse current  $I_{RM}$  versus  $di_F/dt$

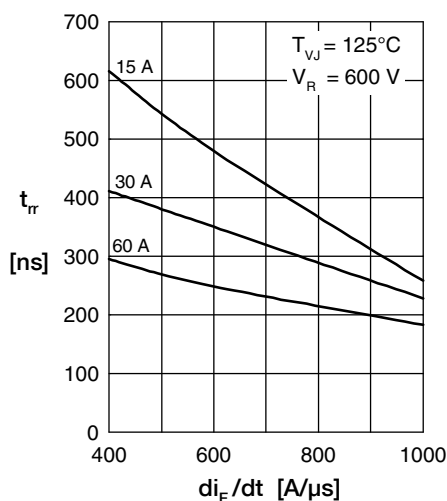


Fig. 4 Dynamic parameters  $Q_{rr}$ ,  $I_{RM}$  versus  $T_{VJ}$

Fig. 5 Typ. recovery time  $t_{rr}$  versus  $di_F/dt$

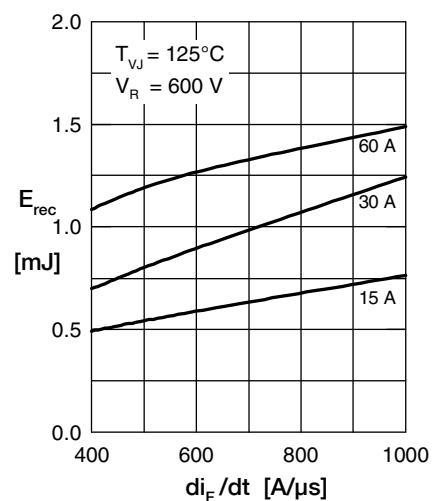


Fig. 6 Typ. recovery energy  $E_{rec}$  versus  $di_F/dt$

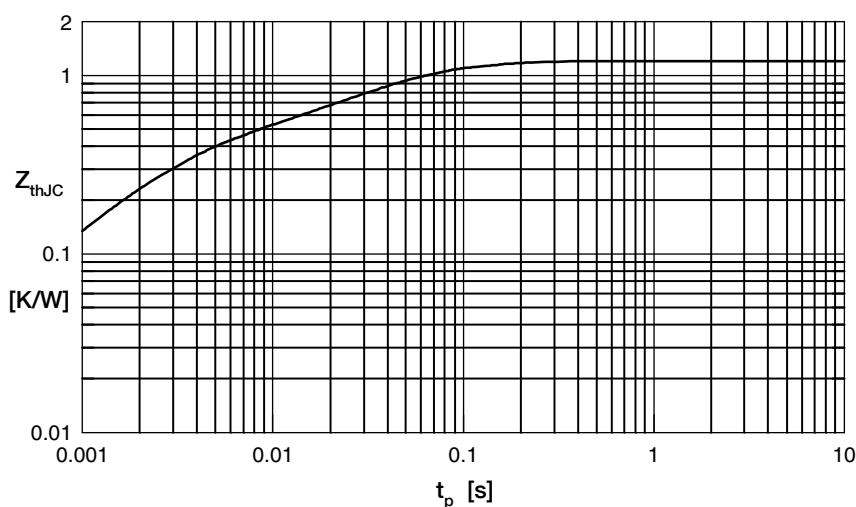


Fig. 7 Typ. transient thermal impedance

## Inverter IGBT

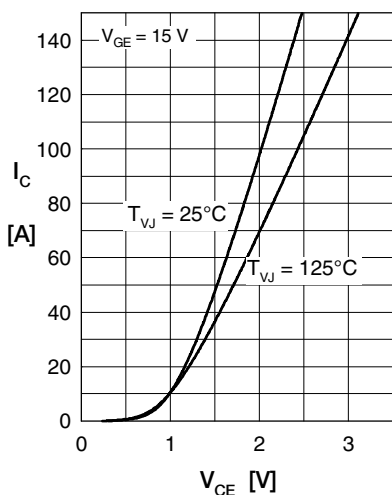


Fig. 1 Typ. output characteristics

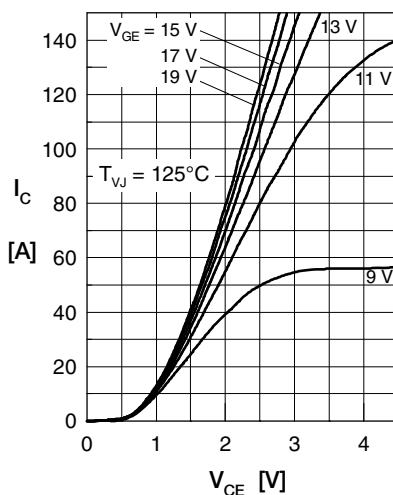


Fig. 2 Typ. output characteristics

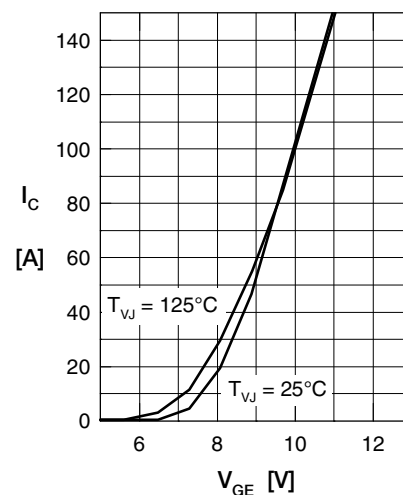


Fig. 3 Typ. transfer characteristics

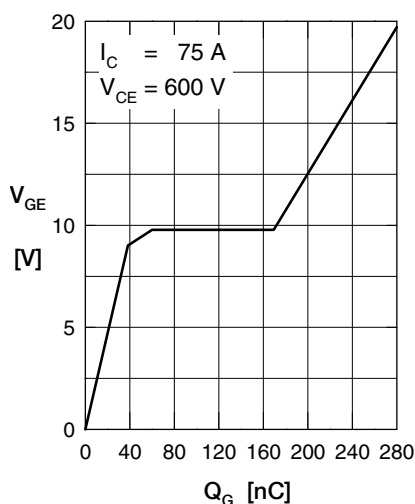


Fig. 4 Typ. turn-on gate charge

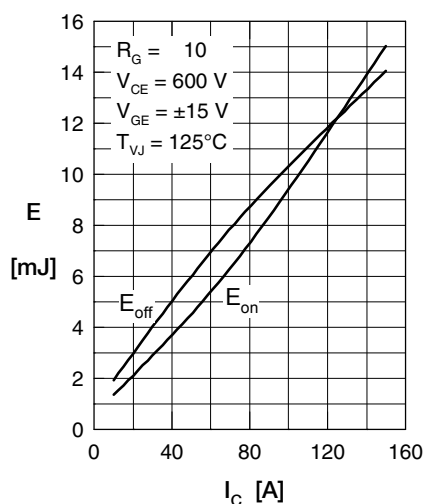


Fig. 5 Typ. switching energy versus collector current

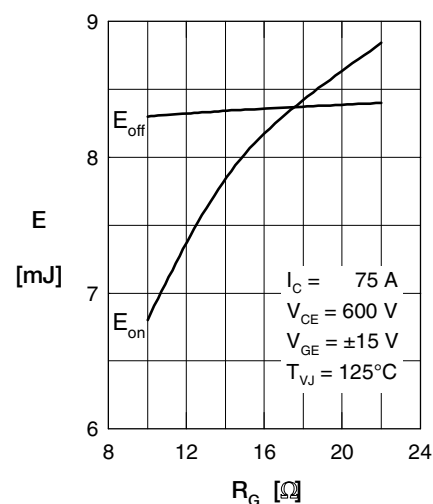


Fig. 6 Typ. switching energy versus gate resistance

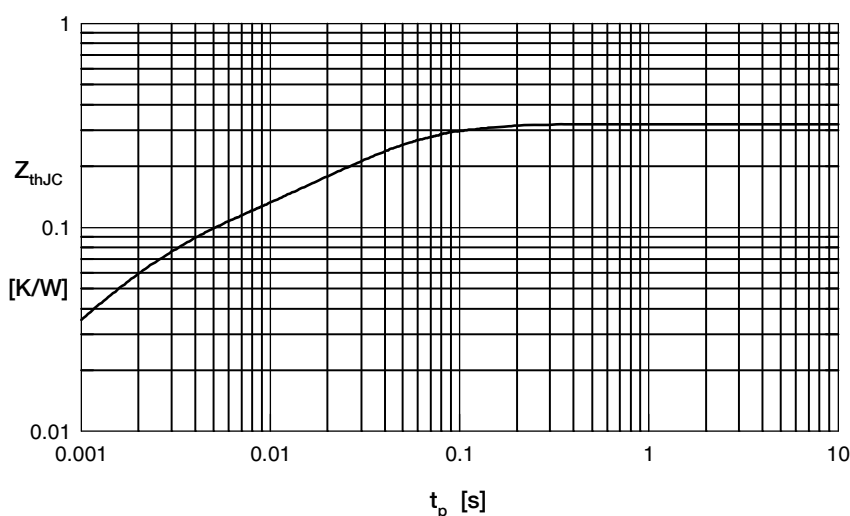


Fig. 7 Typ. transient thermal impedance

## Inverter Diode

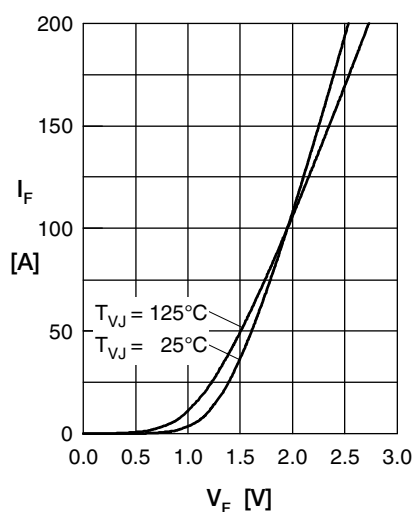


Fig. 1 Typ. Forward current  $I_F$  versus  $V_F$

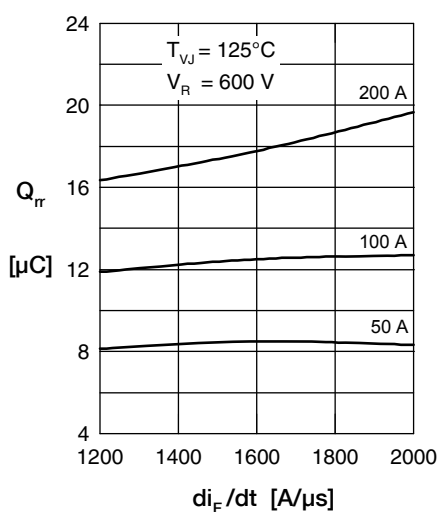


Fig. 2 Typ. reverse recov. charge  $Q_{rr}$  versus  $di_F/dt$

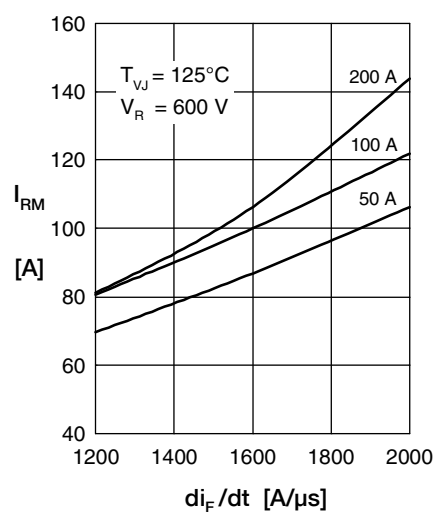


Fig. 3 Typ. peak reverse current  $I_{RM}$  versus  $di_F/dt$

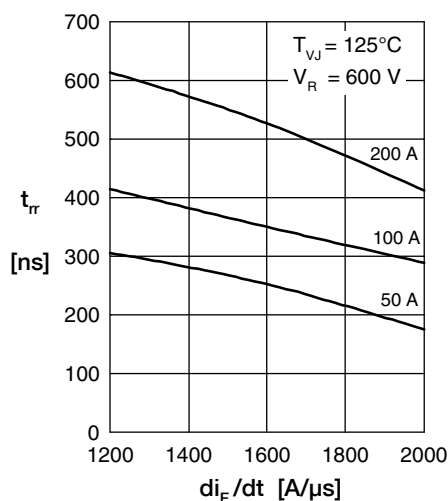


Fig. 4 Dynamic parameters  $Q_r$ ,  $I_{RM}$  versus  $T_{VJ}$

Fig. 5 Typ. recovery time  $t_{rr}$  versus  $di_F/dt$

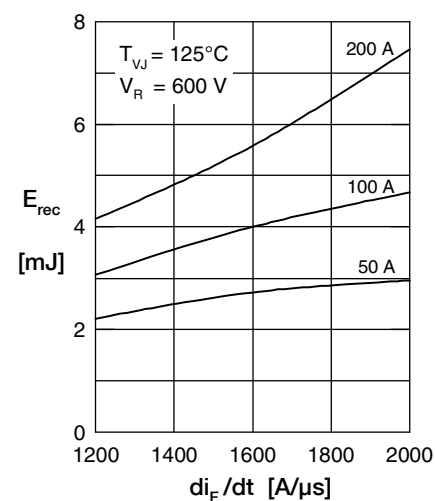


Fig. 6 Typ. recovery energy  $E_{rec}$  versus  $di_F/dt$

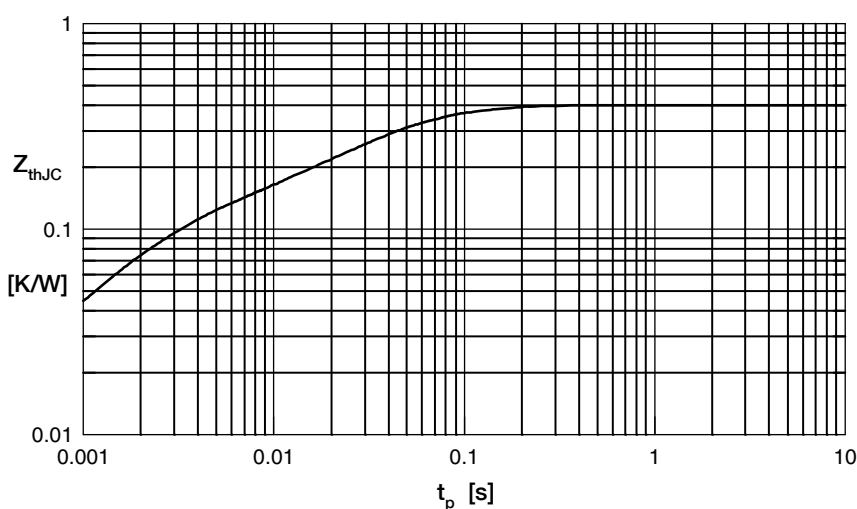


Fig. 7 Typ. transient thermal impedance